

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3603534

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIDEO SAWADA	08/04/2015
RECEIVING PARTY DATA	
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PROPERTY NUMBERS Total: 1	
Property Type	Number
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DATE SIGNED:	11/05/2015
Total Attachments: 1	
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ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) Hideo SAWADA (3) _____
- (2) _____ (4) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto HIROSAKI UNIVERSITY, an organization existing under the laws of Japan having its principal office and place of business address located at 1, Bunkyo-cho, Hirosaki-shi, Aomori, JAPAN, and its successors and assign (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

**FLUORINE-CONTAINING NANO COMPOSITE PARTICLES
AND METHOD FOR PRODUCING THE SAME**

- (a) for which an application for United States Letters Patent was filed on _____, and identified by United States Serial No. _____; or
- (b) for which an international application designating the United States was filed on _____, and identified by International Application No. _____; or
- (c) for which an application for United States Letters Patent was executed on _____,

and the right to all benefits under the International Convention of the Protection of Industrial Property to said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; together with the right to recover all damages, including, but not limited to, a reasonable royalty, by reason of past, present, or future infringement or any violation of patent or patent application rights; to have and to hold for the sole and exclusive use and benefit of the ASSIGNEE, its successors and assigns, to the full end of the term or terms for all such patents;

The undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, continuations, or continuations-in-part thereof.

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissue or extended Letters Patent of the United States upon request of said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to said invention; assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

DATE SIGNED

1) Hideo Sawada August 4, 2015
 Name: Hideo SAWADA